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Form PTO-1595 RE(	U.S. DEPARTMENT OF COMMERCE
(Rev. 03/ 01) OMB No. 0651-0027 (exp. 5/31/2002)	259087 U.S. Patent and Trademark Office
To the Honorable Commissioner of Patents and Trademarks: F	Please record the attached original documents or copy thereof
Name of conveying party(ies):	2. Name and address of receiving party(ies)
LEEM, See Jong	Name: LG ELECTRONICS INC.
	Name: LG ELECTRONICS INC. 00
	Street Address:
Additional name(s) of conveying party(ies) Yes X No	Street Address:
3. Nature of Conveyance:	
X Assignment Merger	
Security Agreement Change of Name	City: Seoul
Other	Country Korea Zip:
Execution Date: June 12, 2006	Additional name(s) & XYes No address(es) attached:
4. Application number(s) or patent number(s):	
Additional numbers attach	ned? Yes No
5. Name and address of party to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved:
Name: Song K. Jung MCKENNA LONG & ALDRIDGE LLP	7. Total fee (37 CFR 3.41) \$ 40.00
Internal Address: Atty. Dkt.: 8736.090.00	X Enclosed
Street Address:	Authorized to be charged to deposit account
1900 K STREET, N.W.	Authorized to be charged to credit card (Form 2038 enclosed)
	8. Deposit account number:
City: State: Zip: WASHINGTON DC 20006	50-0911
	(Attach duplicate copy of this page if paying by deposit account)
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<ol> <li>Statement and signature.</li> <li>To the best of my knowledge and belief, the foregoing inf is a true copy of the original document.</li> </ol>	ormation is true and correct and any attached copy
Mark R. Kresloff Name of Person Signing	Signature June 12, 2006 Date
Total number of pages including cover sheet, attac	chments, and documents: 4

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DC:50415958.1

2. Name and address of receiving party(ies)

Name:

LG INNOTEK CO., LTD

Internal Address:

Street Address:

LG Twin Towers 33/34F, Yeouido-dong

Yeongdeungpo-gu,

City: Seoul

Country: Korea

Zip: 150-721

Additional name(s) &

---

Address(es) attached:

Yes:

No

2

Docket No.:8736.085.00-US

DC:50415958.1

PATENT REEL: 017992 FRAME: 0874

Docket No.:

## Assignment of Application

WHEREAS, (WE	) Leem, See jong	
		, respectively,
have invented certain ne	w and useful improvements in:	
METHOD	FOR MANUFACTURING LIGHT EMI	TTING DIODES
	for Letters Patent was executed on	
ZA 31 Z 32 1		
(Application No.	, Filed	), and
WHEREAS, LG	ELECTRONICS INC. AND LG INNOTI	EK CO., LTD
(hereinafter referred to a	s 팀 SSIGNEES? having a place of busines	ss at: 20, Yoido-dong.

Youngdungpo-gu, Seoul 150-875, Republic of Korea and LG Twin Towers 33/34F, Yeouido-dong, Yeongdeungpo-gu, Seoul 150-72I, Republic of Korea

is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent that may be granted therefore in the United States and its territorial possessions and in any and all foreign countries;

NOW, THEREFORE, in consideration of the sum of FIVE DOLLARS (\$5.00), the receipt whereof is hereby acknowledged, and for other good and valuable consideration, I (WE), by these presents do sell, assign and transfer unto said ASSIGNEE, the full and exclusive right to the said invention in the United States and its territorial possessions and in all foreign countries and the entire right, title and interest in and to any and all Letters patent which may be granted therefore in the United States and its territorial possessions and in any and all foreign countries and in and to any and all divisions, reissues, continuations, substitutions and renewals thereof.

(WE) hereby authorize and request the Patent Office Officials in the United States and Its territorial possessions and any and all foreign countries to issue any and all of said Letters Patent, when granted, to said ASSIGNEE as the assignee of my (our) entire right, title and interest in and to the same, for the sole use and behalf of said ASSIGNEE, its (his) successors and assigns, to the full end of the term for which said Letters Patent may be granted, as fully and entirely as the same would have been held by me (us) had this Assignment and sale not been made.

Further, (WE) agree that (WE) will communicate to said ASSIGNEE or its (his) representatives any facts known to me (us) respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, substitute, renewal and reissue applications, execute all necessary assignment papers to cause any and all of said Letters Patent to be issued to said ASSIGNEE, make all rightful oaths, and, generally do everything possible to aid said ASSIGNEE, its (his) successors and assigns, to obtain and enforce proper protection for said invention in the United States and its territorial possessions and in any and all foreign countries.

Page 1 of 2

PATENT REEL: 017992 FRAME: 0875

We hereby claim the application(s) listed below.	e benefit under Title 35, Un	ited States Code, ?	19(e) of any United	States provisional
(App)	ication Number)	(Filing	g Date)	

We hereby claim the benefit under 35 U.S.C. ? 20 of any United States application(s), or ? 65(c) of any PCT International application designating the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT International application in the manner provided by the first paragraph of 35 U.S.C. ? 12, I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR ? .56 which became available between the filing date of the prior application and the national or PCT International filing date of this application.

Application Serial No.	Filing Date	Status (pending, patented, abandoned)

We declare that all statements made herein of our (my) own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon, and may jeopardize the validity of the patent application or any patent issued thereon.

Leem, See jong	Residence: 101-202, Poonglim Apt., 460,			
NAME OF FIRST INVENTOR	Hongeun 2(i)-dong, Scodaemun-gu, Scoul 120-102, Republic of Korea			
9 11 3	-			
Signature of Inventor	Citizen of: Republic of Korea			
T . 12 2006	Post Office Address: Same as Ahove			

Date

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RECORDED: 06/12/2006

PATENT REEL: 017992 FRAME: 0876